



<p>Milano, 21/02/24 FROM: RADICE ROBERTO</p> <p>In case of purchase, send your order to: orders@electron-mec.com</p> <p>ATTN: MATTEO D'ANDREA</p>	<p>TO: INAF ROMA VIA DEL FOSSO DEL CAVALIERE, 100</p> <p>00133 ROMA P.IVA-VAT: 06895721006</p>
---	--

<p>QUOTATION NO. 3221 REF: TPT</p>	<p>TERMS OF PAYMENT: B.B. 1 MESE D.F. F.M.</p>
---	---

P/N	DESCRIPTION	UNIT PRICE EUR	QUANTITY	TOTAL PRICE EUR
H69-1	<p>Bond Starter Kit for HB16 Wedge & Ball Bonder H69-1 - Starter Kit for HB16 For Wedge & Ball Bonder, including: H60-21 - Gold Wedge 25µm - 3 pcs H61-1 - Capillary 25µm 11mm - 3 pcs H60-40 - Aluminum Wedge 25µm - 3 pcs H70-21 - Gold Wire 25µm, 100m, HD2 - 1 pc H74-41 - Aluminum Wire 25µm, 100m, AISi 1% - 1 pc H68-2 - TPT PCB Bond Sample - 3 pcs H65 - Unplugging Probe Needle - 25 pcs H66 - Unplugging Tungsten Wire - 10 pcs H67 - TPT Tweezers - 2 pcs</p>	1.715,00	1	1.715,00
E-DAP	<p>Equipment import, crating and documentation fees, Insurance, delivery DAP</p>	210,00	1	210,00

VAT NOT INCLUDED

QUOTATION VALIDITY: 22/03/24
INCOTERMS DELIVERED AT PLACE/
WARRANTY: NA
DELIVERY TIME: 8 WEEKS ARO

Pagina 1 di 1

TOTALE EUR	1.925,00
------------	-----------------